

## N-Channel Trench Power MOSFET

### General Description

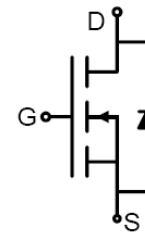
The JY2302A uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a battery protection or in other switching application.

### Features

- $V_{DS} = 20V, I_D = 2.9A$   
 $R_{DS(ON)} = 42m\Omega(\text{typ}) @ V_{GS} = 4.5V$   
 $R_{DS(ON)} = 60m\Omega(\text{typ}) @ V_{GS} = 2.5V$
- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

### Application

- Battery protection
- Load switch
- Power management



Schematic Diagram



SOT-23 top view

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
2302 or 230 <u>2</u>	JY2302A	SOT-23	Ø180mm	8mm	3000 units

Table 1. Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ )

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	20	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 12$	V
$I_D$	Drain Current-Continuous	2.9	A
$I_{DM (pluse)}$	Drain Current-Continuous@ Current-Pulsed (Note 1)	8	A
$P_D$	Maximum Power Dissipation	1	W
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	$^\circ\text{C}$

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

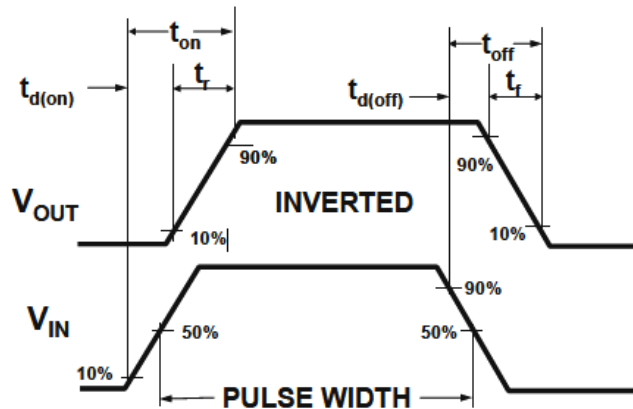
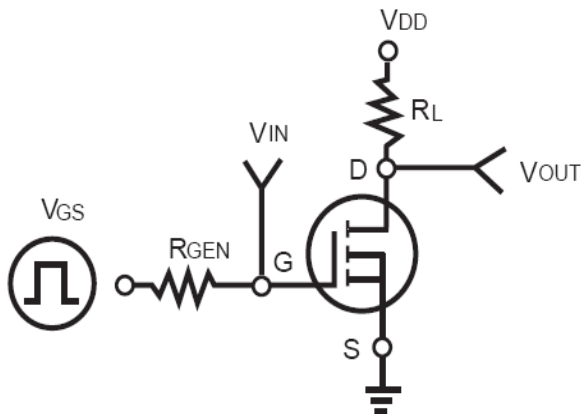
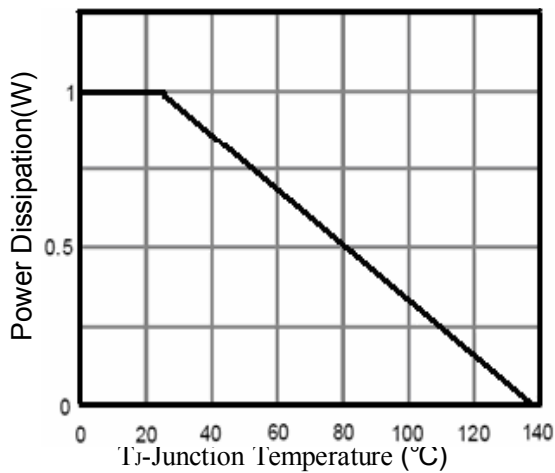
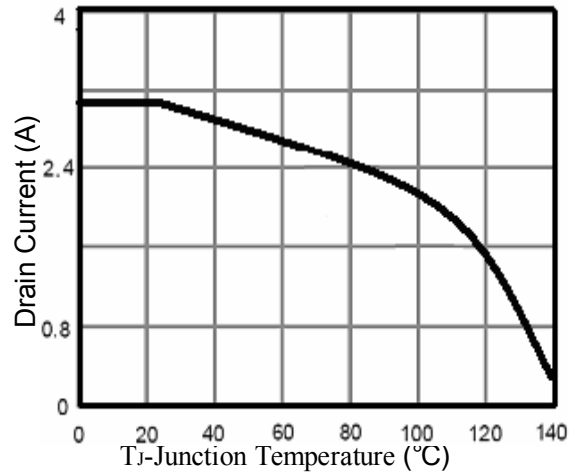
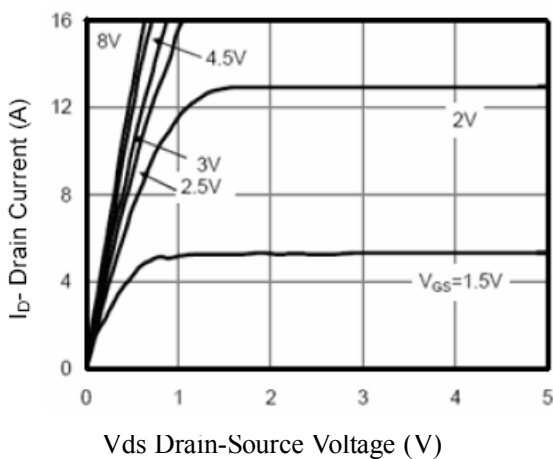
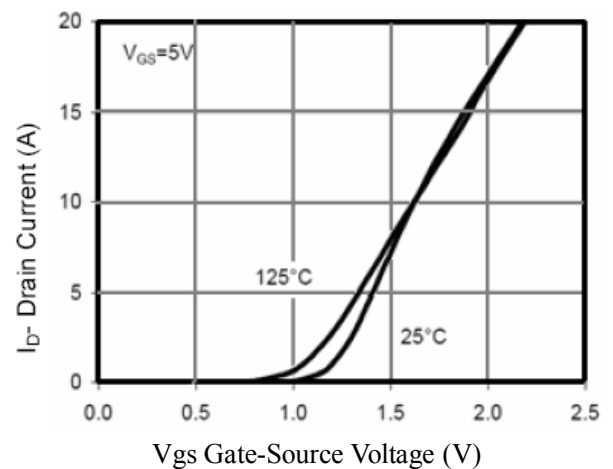
Table 2. Thermal Characteristic

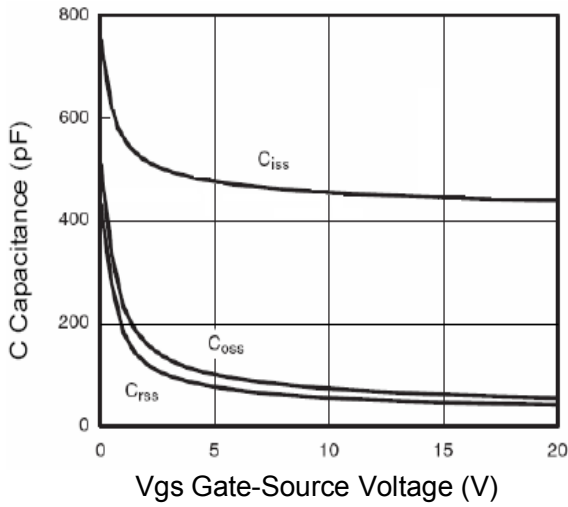
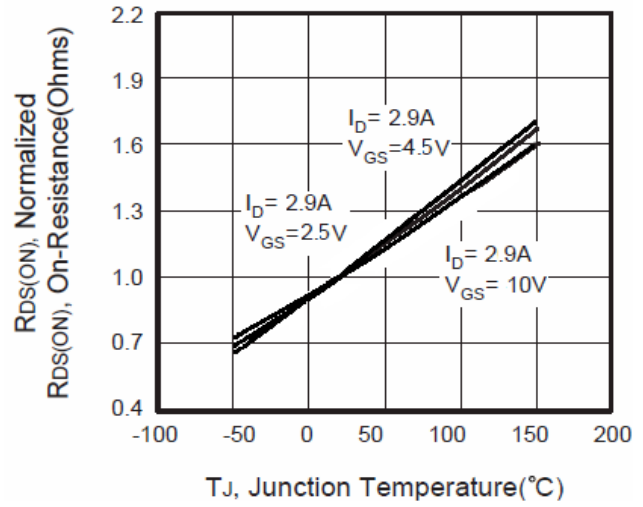
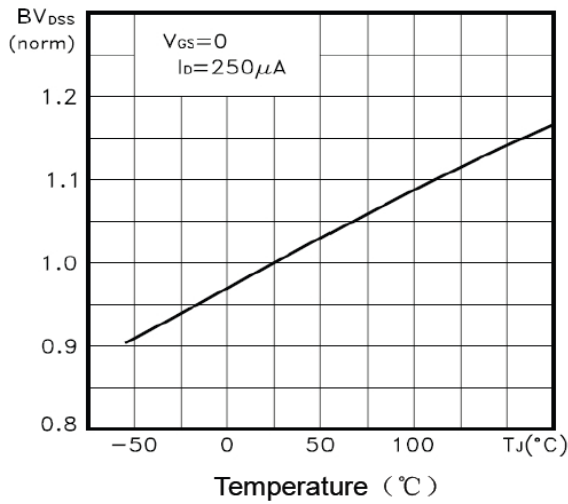
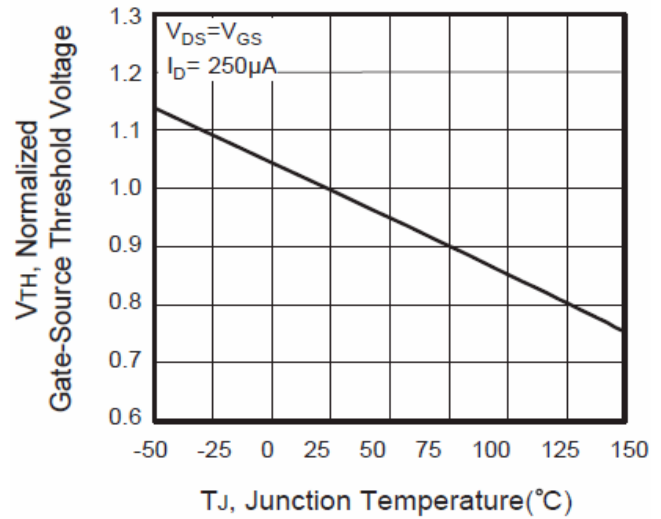
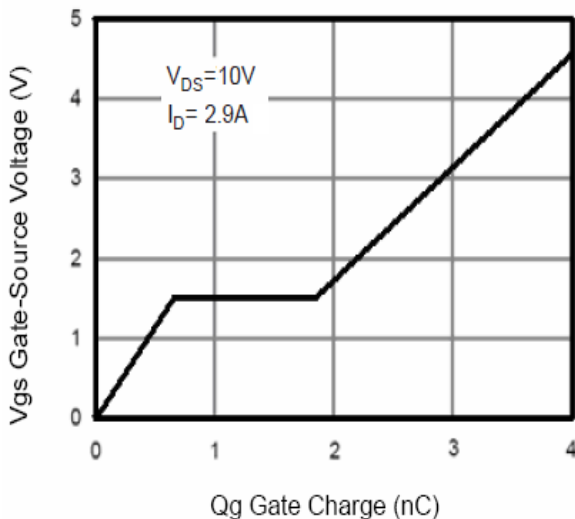
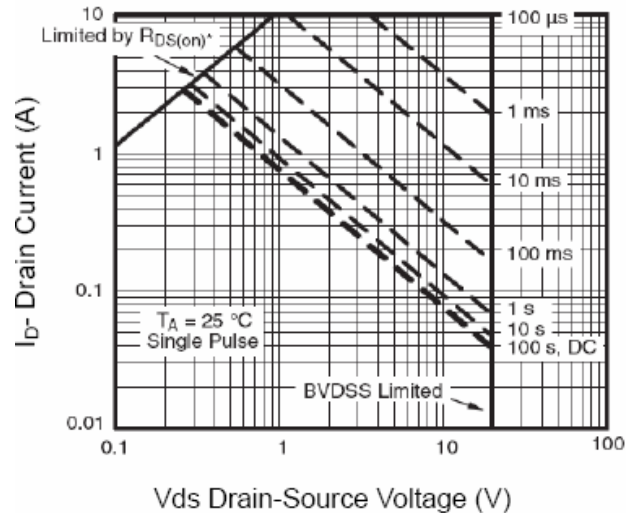
Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	125	$^\circ\text{C/W}$

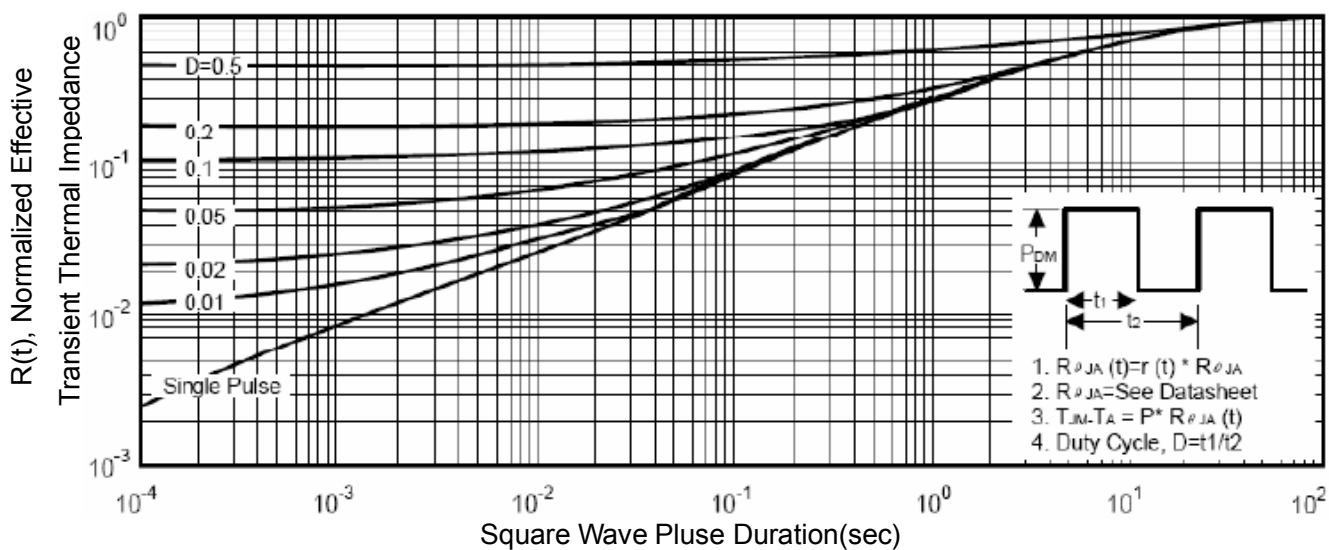
**Table 3. Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
B <sub>V</sub> DSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	20	22		V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =19V, V <sub>GS</sub> =0V			1	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V			±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.4	0.7	1	V
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =5V, I <sub>D</sub> =2.9A	4	8		S
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =4.5V, I <sub>D</sub> =3A		42	55	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =2A		60	85	mΩ
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =10V, V <sub>GS</sub> =0V, f=1.0MHz		480		pF
C <sub>oss</sub>	Output Capacitance			86		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			56		pF
<b>Switching Times</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> =10V, I <sub>D</sub> =2.9A, R <sub>L</sub> =2.8Ω V <sub>GS</sub> =4.5V, R <sub>G</sub> =6Ω		11		nS
t <sub>r</sub>	Turn-on Rise Time			52		nS
t <sub>d(off)</sub>	Turn-Off Delay Time			17		nS
t <sub>f</sub>	Turn-Off Fall Time			10		nS
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =10V, I <sub>D</sub> =2.9A, V <sub>GS</sub> =4.5V		4		nC
Q <sub>gs</sub>	Gate-Source Charge			0.7		nC
Q <sub>gd</sub>	Gate-Drain Charge			1.2		nC
<b>Source-Drain Diode Characteristics</b>						
I <sub>SD</sub>	Source-Drain Current(Body Diode)				2.9	A
V <sub>SD</sub>	Forward on Voltage <b>(Note 1)</b>	V <sub>GS</sub> =0V, I <sub>S</sub> =2.9A		0.75		V

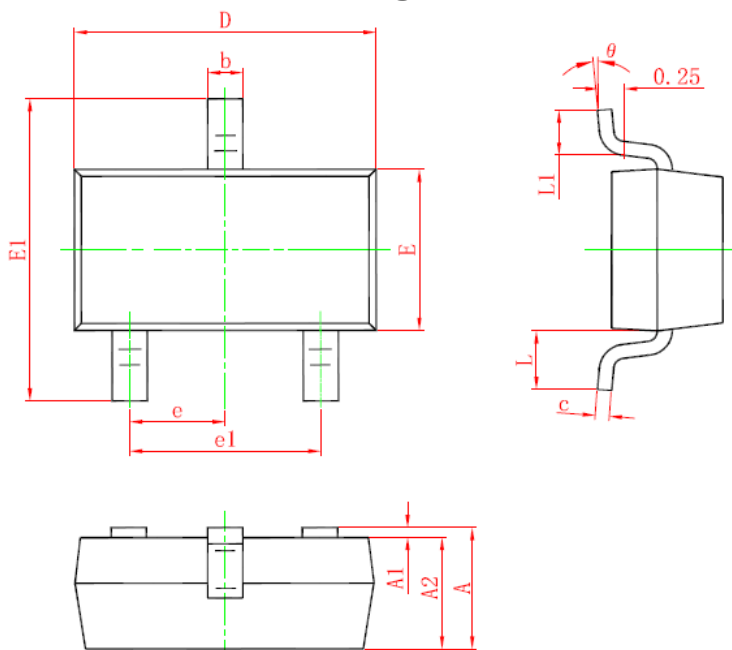
Notes 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

**Switch Time Test Circuit and Switching Waveforms:**

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)**
**Figure1. Power Dissipation**

**Figure2. Drain Current**

**Figure3. Output Characteristics**

**Figure4. Transfer Characteristics**


**Figure5. Capacitance**

**Figure6.  $R_{DS(ON)}$  vs Junction Temperature**

**Figure7. Max  $BV_{DSS}$  vs Junction Temperature**

**Figure8.  $V_{GS(th)}$  vs Junction Temperature**

**Figure9. Gate Charge Waveforms**

**Figure10. Maximum Safe Operating Area**


**Figure11. Normalized Maximum Transient Thermal Impedance**


### SOT-23 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP.		0.037 TYP.	
e1	1.800	2.000	0.071	0.079
L	0.550 REF.		0.022 REF.	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

### Carrier Dimensions

PKG TYPE	W	P	E	F	D	D1	Po	Po10	P2
SOT-23	8.00	4.00	1.75	3.50	1.50	1.00	4.00	40.00	2.00
Tolerance	+0.3/-0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.1	±0.2	±0.05

A0	B0	K0	T
3.15	2.77	1.22	0.20
±0.1	±0.1	±0.1	±0.02

